



18W LED Lump Module Design with FT881

(Preliminary Release)





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1 INTRODUCTION

This document presents performance characteristics of a buck converter module designed with FT8881. The module features:

- high precision for output current in universal input voltage.
- Simple circuit.

This document contains sessions on power supply specification, schematic/PCB Gerber/BOM, Power Inductor design and performance data.

2 MODULE SPECIFICATION

2.1 Input Characteristics

AC Input Voltage Rating	100Vac to 240Vac
AC Input Voltage Range	90Vac to 264Vac
AC Input Frequency	47Hz to 63Hz

Table 1

2.2 Output Characteristics

Output Voltage	46V Open Load
Output Current	400mA
Precision of Output Current	$\pm 3\%$
Ripple of Output Voltage	< 1.5V
Ripple of Output Current	< 200mA

Table 2

Note: Ripple of Output Voltage is measured with 20MHz bandwidth limited (peak to peak value).

2.3 Performance Specification

Total Output Power	18W Typical
Standby Power	< 0.5W @ 90Vac~265Vac, no load
Efficiency	>85% with full load
Turn on Delay Time	10msec. max. @ 90Vac/50Hz with full load
Central Switching Frequency	50 KHz

Table 3

2.4 Protection Features

Short Circuit Protection	Output shut down (Auto Recovery)
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Table 4

2.5 Environmental

Operating Temperature	-20°C to +40°C
Operating Humidity	20 % to 90 % R. H.
Storage Temperature	-40°C to 85°C
Storage Humidity	0 % to + 90 % R. H.

Table 5

3 MODULE INFORMATION

3.1 Schematic

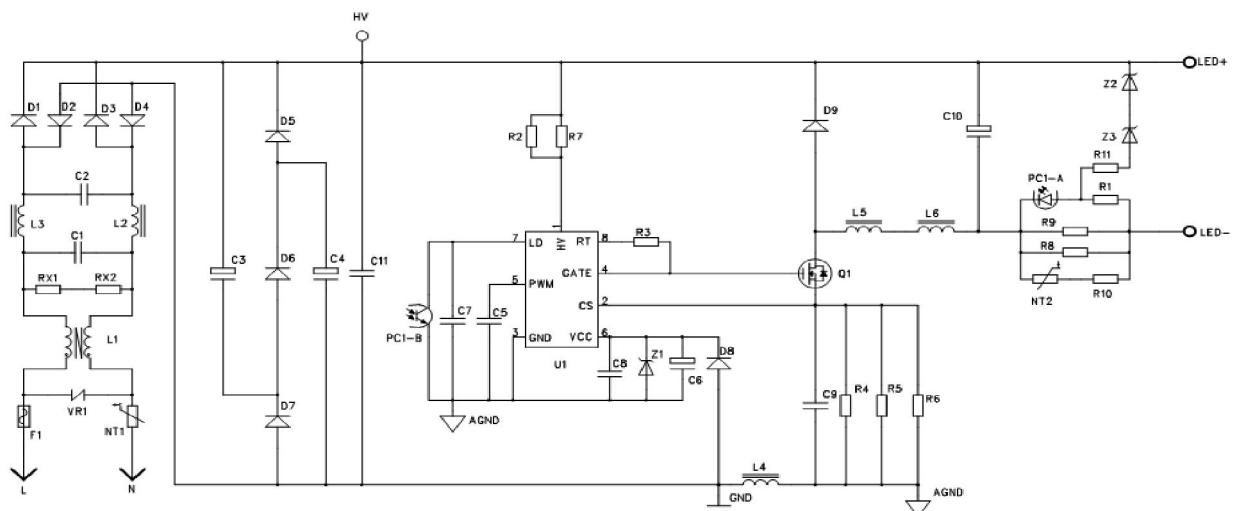


Figure 1: Schematic

3.2 PCB Gerber

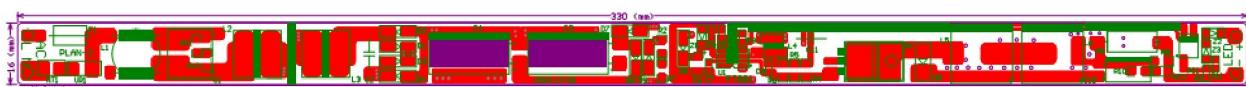


Figure 2: Top View

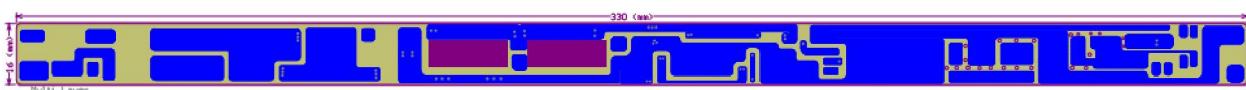


Figure 3: Bottom view



3.3 Bill of Materials

Ref Des	Description	Package	Part Num	QTY
C1, C2	X2 Capacitor 0.1uF K X2 275Vac, Pin Range: 10 mm			2
C3, C4	Electrolytic Capacitor 22uF/250V, -40 to +105°C, 10*20 mm			2
C5	Ceramic Capacitor 1nF/25V	0805		1
C6	Tantalum Capacitor 4.7uF/25V, B Type	MLL34		1
C7, C8	Ceramic Capacitor 100nF/25V	0805		2
C9	Ceramic Capacitor 100pF/25V	0805		1
C10	Electrolytic Capacitor 10uF/100V, -40 to +105°C, 6.3*12 mm			1
C11	CBB capacitor 68nF/400V, Pin Range: 10 mm			1
D1, D2, D3, D4, D5, D6, D7	Rectifier diode	SMA	M7	7
D8	Fast Rectifier diode	SMA	ES1J	1
D9	Fast Rectifier diode	SMB	MURS260T3	1
F1	Fast Acting Fuse		F1A250Vac	1
L1	Common Mode Inductor, 25mH			1
L2, L3	Shielded Power Inductor, 1.5mH	SMD		2
L4	Shielded Inductor, 4.7uH	SMD		1
L5, L6	Power Inductor, 1mH EFD15-H, 8 Pin, cut out Pin4 and Pin5			2
NT1	Surge Current Suppress NTC Thermistor		SCK05052	1
NT2	NTC Thermistor		MF11-500K3000JA	1
PC1	Photo Coupler		EL817	1
Q1	N Channel MOS FET	TO-220	FQPF5N60C	1
R1	Thick Film Chip Resistor, 470R	0805		1

Table 6-1

Ref Des	Description	Package	Part Num	QTY
R2, R7	Thick Film Chip Resistor, 22K	1206		2
R3	Thick Film Chip Resistor, 330K	0805		1
R4, R5, R6	Precision Thick Film Chip Resistor, 1.1R Precision: $\pm 1\%$	1206		3
R8	Thick Film Chip Resistor, 20R	1206		1
R9	Precision Metal Film Resistor, 3.3R/1W Precision: $\pm 1\%$			1
R10	Thick Film Chip Resistor, 47R	1206		1
R11	Thick Film Chip Resistor, 220R	0805		1
RX1, RX2	Thick Film Chip Resistor, 750K	1206		2
U1	IC	SO-8	FT881	1
VR1	Varistor		VDR 07D471K	1
Z1	Zener, 12Vz	SOD80		1
Z2, Z3	Zener, 22Vz	SOD80		2

Table 6-2

3.4 Power Inductor Design

- 1) Bobbin: EED15 Horizontal (8Pin)
- 2) Core Material: PC40 (TDG).
- 3) Inductance: 1000uH +/- 50uH (1 KHz, 0.25V, 25°C) (Pin2 to Pin7).
- 4) Cut out Pin: Pin4, Pin5.
- 5) Winding: $\Phi 0.19\text{mm} * 2$, 160 turns.

3.5 Module Snapshot



Figure 6: Top View



Figure 7: bottom View

4 PERFORMANCE EVALUATION

Performance Highlights:

The efficiency over 90Vac ~264Vac is $\geq 84\%$

The standby power is < 0.5W at 90Vac/50Hz with no load

Characterization Results Summary

Test	Specification	Test
1. Input Characteristics		
Input Voltage	90~264 V	90~264 V
Input Current	< 0.5 A	Max: 0.228 A @ 90Vac
Standby power	≤ 0.5 W	Max: 0.45 W @ 264Vac
Efficiency (Average)	$\geq 86\%$	86.23 %
2. Output Characteristics		
Output Voltage Range	36~50 V	37.3 ~ 46.1 V
Output Current Range	388 ~ 412 mA	0.403 ~ 0.410 mA
Output Voltage Ripple	< 1.5 V	Max: 1.37V @ 90Vac
Output Current Ripple	< 200 mA	Max: 160mA @ 90Vac
3. Time Sequence		
Turn on delay time	<10 mS	5.8 mS
Hold up time	--	28 ms
4. Protection		
Short Circuit protection	Pass	Pass

Table 9

4.1 Input Characteristics

1) Input Normal Characteristics

The module was tested at different input voltages (from 90Vac to 264Vac) and different load conditions (full load and no load). Efficiency and standby power were measured and listed in table 10 and table 11.

Input				Output			Specification	Test Result
Voltage(V)	Irms(A)	Pin(W)	PF(%)	Vo(V)	Io(A)	η(%)		
90V/50Hz	0.228	17.60	85.3	37.40	0.403	85.64	> 85%	Pass
110V/60Hz	0.181	17.47	87.6	37.50	0.404	86.72		
220V/50Hz	0.097	17.66	82.4	37.57	0.408	86.80		
264V/50Hz	0.085	17.83	79.0	37.30	0.410	85.77		

Table 10: Input characteristics at full load

2) Standby Power

Input Voltage	Vo(V)	Input Power(W)	Specification	Test Result
90V/50Hz	46.0	0.21	≤ 0.5	Pass
110V/60Hz	46.0	0.23		
220V/50Hz	46.0	0.38		
264V/50Hz	46.1	0.45		

Table 11: Standby power at no load

4.2 Output Characteristics**1) Precision of Output Current**

Input Voltage	90V	115V	220V	264V	Precision
Output Current	0.403 A	0.404 A	0.408 A	0.410 A	0.388 ~ 0.412 A

Table12: Precision of Output Current

2) Ripple

Input Voltage	90V	115V	220V	264V
Ripple of Output Voltage	1370 mV	310 mV	306 mV	360 mV

Table13: Ripple of Output Voltage

Input Voltage	90V	115V	220V	264V
Ripple of Output Current	160 mA	58 mA	56 mA	57 mA

Table14: Ripple of Output Current

Note: Ripple of Output Voltage is measured with 20MHz bandwidth limited (peak to peak value) .

3) Time Sequence

Time sequence parameters were measured with DSO.

Item	Input Voltage	Test Result	Remark
Turn-on Delay	90V/50Hz	5.8 mS	Figure 8
Hold up Time	264V/50Hz	28.0 mS	Figure 9

Table 15: turn-on delay /hold-up time measurement results

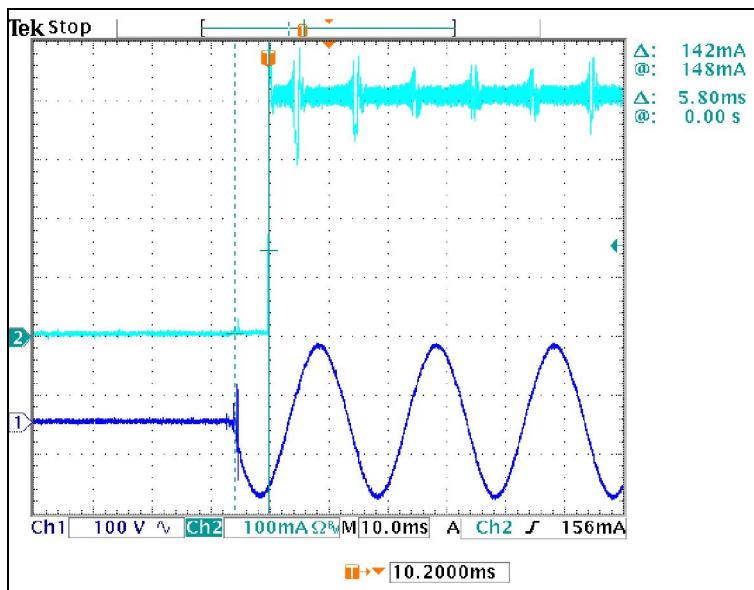


Figure 8: Turn on delay time measured waveform @ 90Vac/50Hz, full load

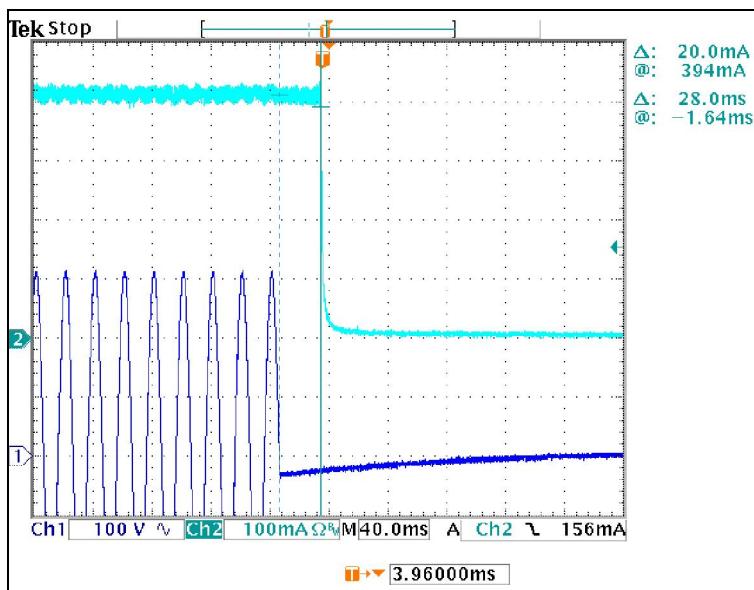


Figure 9: Hold on delay time measured waveform @ 264Vac/50Hz, full load

4.3 Protection

1) Open Circuit Protection

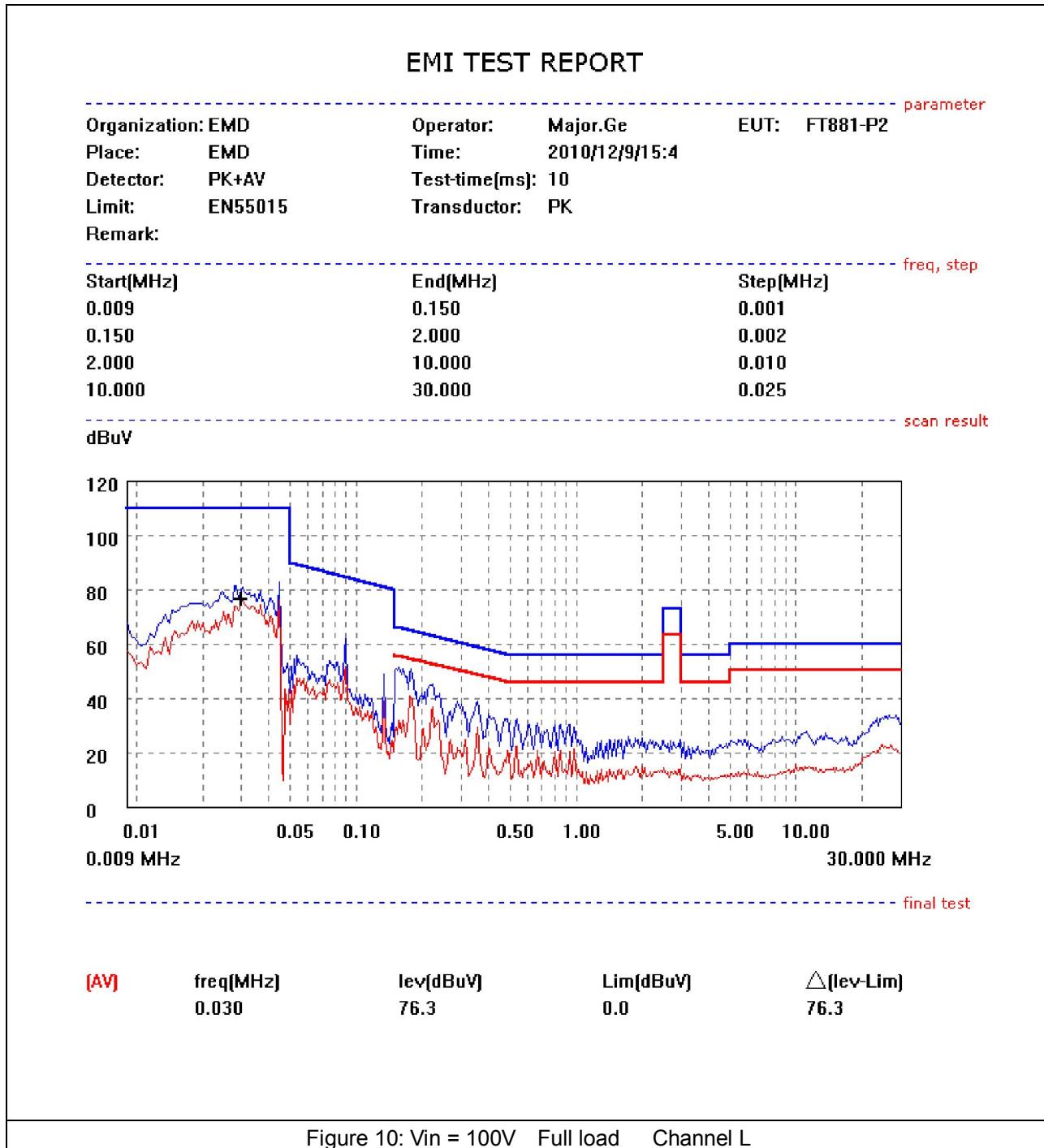
The system is protected during output open circuit condition and recovered when open circuit condition is removed.

2) Short Circuit Protection

The system is protected during output short circuit condition and recovered when short circuit condition is removed.

4.4 EMI Test

The Power supply passed EN55015 Class B EMI requirement with more than 4dB margin.

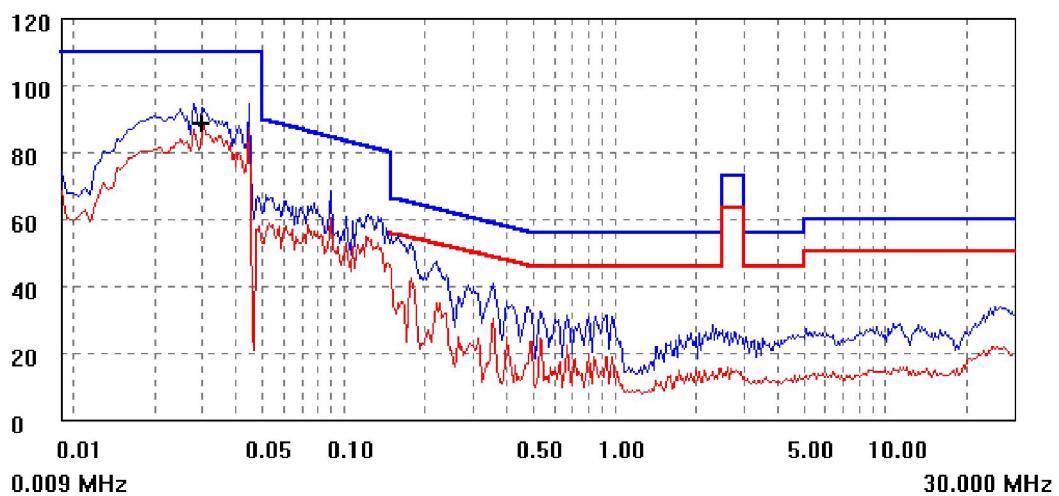


EMI TEST REPORT

Organization: EMD Operator: Major.Ge EUT: FT881-P2 parameter
Place: EMD Time: 2010/12/9/14:59
Detector: PK+AV Test-time(ms): 10
Limit: EN55015 Transductor: PK
Remark:

Start(MHz)	End(MHz)	Step(MHz)	freq, step
0.009	0.150	0.001	
0.150	2.000	0.002	
2.000	10.000	0.010	
10.000	30.000	0.025	

dBuV scan result



final test

[AV]	freq[MHz]	lev[dBuV]	Lim[dBuV]	△[lev-Lim]
	0.030	88.4	0.0	88.4

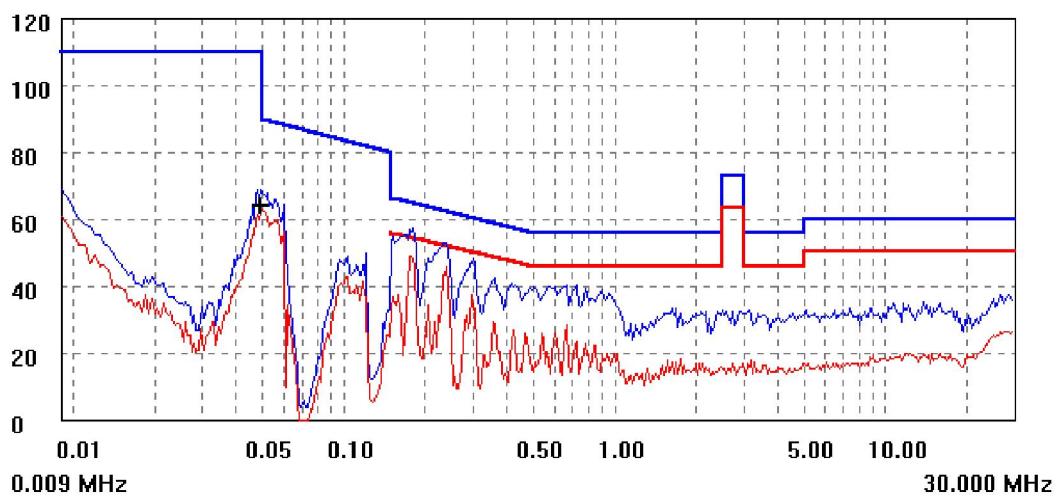
Figure 10: Vin = 100V Full load Channel N

EMI TEST REPORT

Organization: EMD Operator: Major.Ge EUT: FT881-P2 parameter
Place: EMD Time: 2010/12/9/15:9
Detector: PK+AV Test-time(ms): 10
Limit: EN55015 Transductor: PK
Remark:

Start(MHz)	End(MHz)	Step(MHz)	freq, step
0.009	0.150	0.001	
0.150	2.000	0.002	
2.000	10.000	0.010	
10.000	30.000	0.025	

dBuV scan result



final test

[AV]	freq[MHz]	lev[dBuV]	Lim[dBuV]	△[lev-Lim]
	0.049	63.8	0.0	63.8

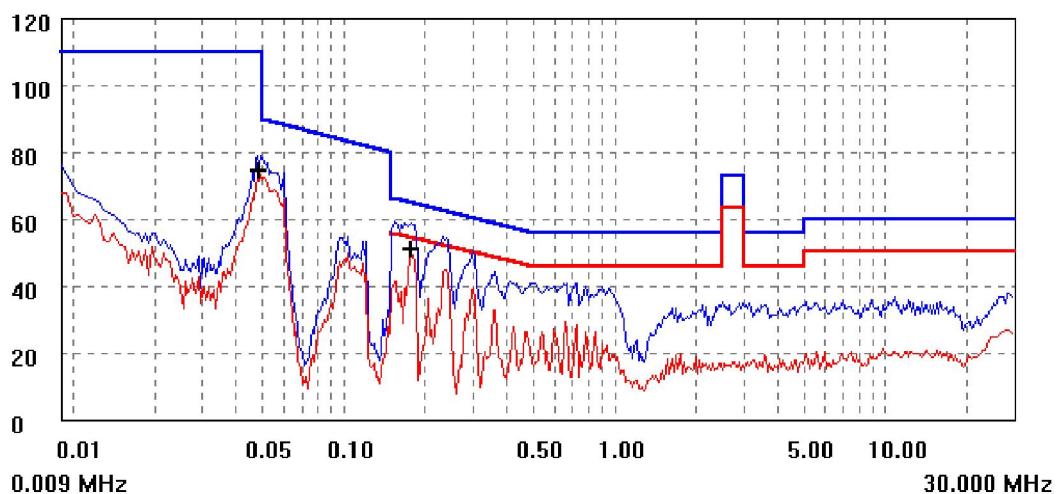
Figure 10: Vin = 230V Full load Channel L

EMI TEST REPORT

Organization: EMD Operator: Major.Ge EUT: FT881-P2 parameter
Place: EMD Time: 2010/12/9/15:18
Detector: PK+AV Test-time(ms): 10
Limit: EN55015 Transductor: PK
Remark:

Start(MHz)	End(MHz)	Step(MHz)	freq, step
0.009	0.150	0.001	
0.150	2.000	0.002	
2.000	10.000	0.010	
10.000	30.000	0.025	

dBuV scan result



final test

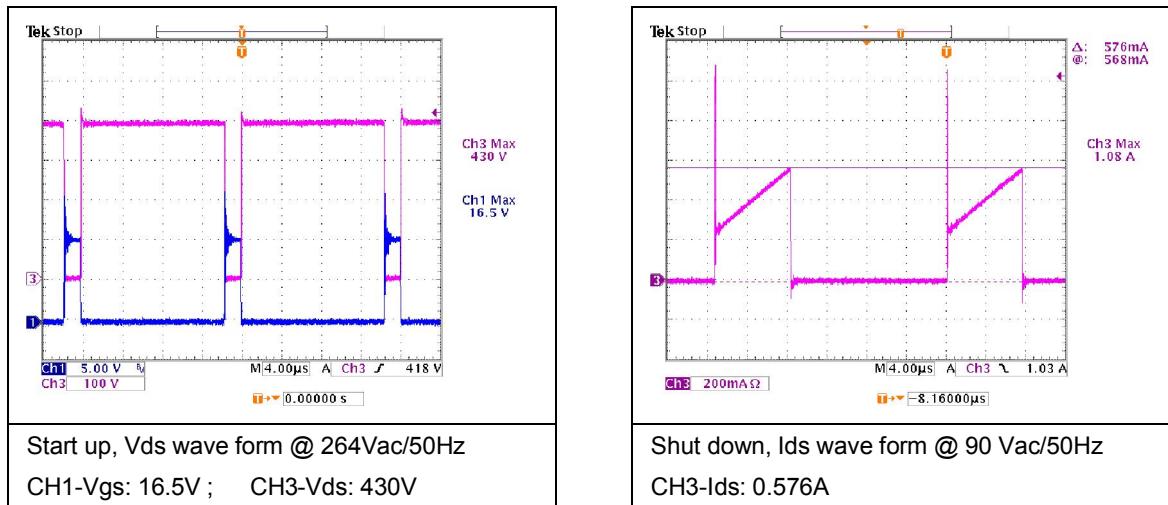
[AV]	freq[MHz]	lev[dBuV]	Lim[dBuV]	△[lev-Lim]
	0.049	74.0	0.0	74.0
	0.178	50.7	55.2	-4.5

Figure 10: Vin = 230V Full load Channel N

Figure 11: Vin = 230V Full load

5 SYSTEM OTHER IMPORTANT WAVEFORM

5.1 MOSFET VDS Wave form at 264Vac, start up/shut down



5.2 Output Rectifier Diode VAK Waveform at Full Load

